Ĺ	Hits	Search Text	DB	Time stamp
Number 1	215409	foil	USPAT; US-PGPUB; EPO; JPO;	2003/01/09 07:50
8	134464	multilayer	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:50
15	337575	reactive :	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:51
22	41320	(separate or remove or peel) near2 (substrate or wafer or glass)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:52
29	36568	(release or adhesion or sacrific\$3) near2 coating	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:53
36	14	foil with multilayer with reactive	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/01/09
43	27	foil same multilayer same reactive	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2003/01/09 07:54
50	1	(foil same multilayer same reactive) and ((separate or remove or peel) near2 (substrate or wafer or glass)) and ((release or adhesion or sacrific\$3)	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:54
57	2	near2 coating) (foil same multilayer same reactive) and ((separate or remove or peel) near2 (substrate or wafer or glass))	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:54
64	1	(foil same multilayer same reactive) and ((release or adhesion or sacrific\$3) near2 coating)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:54
71	3122	foil with multilayer	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:55
78	5	(foil with multilayer) and reactive and ((separate or remove or peel) near2 (substrate or wafer or glass)) and ((release or adhesion or sacrific\$3)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:57
. 85	584	near2 coating)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/01/09 07:57

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	· · · · · · · · · · · · · · · · · · ·	(foil with reactive) and ((separate or	USPAT;	2003/01/09
92	5	remove or peel) near2 (substrate or wafer	US-PGPUB;	08:03
		or glass)) and ((release or adhesion or	EPO; JPO;	**.**
		sacrific\$3) near2 coating)	DERWENT;	
•		Sacrificas, hearz coating,	IBM TDB	ĺ
99	18	(foil with reactive) and ((separate or	USPAT;	2003/01/09
99	10	remove or peel) near2 (substrate or wafer	US-PGPUB;	08:00
		or glass))	EPO; JPO;	
		OI glass//	DERWENT;	
			IBM TDB	
106	28	(foil with reactive) and ((release or	USPAT;	2003/01/09
100	20	adhesion or sacrific\$3) near2 coating)	US-PGPUB;	08:08
		addiesion of sacriffoys, medic coasting,	EPO; JPO;	
			DERWENT;	
1			IBM TDB	
: 113	4	(foil same multilayer same reactive) same	USPAT;	2003/01/09
. 113	•	cool\$3	US-PGPUB;	08:09
		00001-	EPO; JPO;	
į			DERWENT;	
			IBM TDB	

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